



**AOD442, AOD442L (Lead-Free)
N-Channel Enhancement Mode Field Effect Transistor**

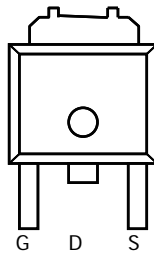
General Description

The AOD442 uses advanced trench technology to provide excellent $R_{DS(ON)}$ and low gate charge. This device is suitable for use as a load switch or in PWM applications. AOD442L is offered in a lead-free package.

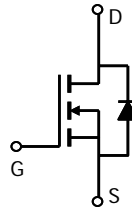
Features

- V_{DS} (V) = 60V
- I_D = 38A
- $R_{DS(ON)} < 20m\Omega$ ($V_{GS} = 10V$)
- $R_{DS(ON)} < 25m\Omega$ ($V_{GS} = 4.5V$)

TO-252
D-PAK



Top View
Drain Connected to
Tab



Absolute Maximum Ratings $T_A=25^\circ\text{C}$ unless otherwise noted

Parameter	Symbol	Maximum	Units
Drain-Source Voltage	V_{DS}	60	V
Gate-Source Voltage	V_{GS}	± 20	V
Continuous Drain Current ^{B,G}	I_D	$T_C=25^\circ\text{C}$ ^G	38
		$T_C=100^\circ\text{C}$ ^B	27
Pulsed Drain Current	I_{DM}	60	A
Avalanche Current ^C	I_{AR}	30	A
Repetitive avalanche energy $L=0.1\text{mH}$ ^C	E_{AR}	140	mJ
Power Dissipation ^B	P_D	$T_C=25^\circ\text{C}$	60
		$T_C=100^\circ\text{C}$	30
Junction and Storage Temperature Range	T_J, T_{STG}	-55 to 175	$^\circ\text{C}$

Thermal Characteristics

Parameter	Symbol	Typ	Max	Units
Maximum Junction-to-Ambient ^A	$R_{\theta JA}$	17.4	25	$^\circ\text{C}/\text{W}$
Maximum Junction-to-Ambient ^A		Steady-State	51	60
Maximum Junction-to-Lead ^C	$R_{\theta JL}$	1.8	2.5	$^\circ\text{C}/\text{W}$

Electrical Characteristics (T_J=25°C unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Units
STATIC PARAMETERS						
BV _{DSS}	Drain-Source Breakdown Voltage	I _D =250μA, V _{GS} =0V	60			V
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} =48V, V _{GS} =0V T _J =55°C			1 5	μA
I _{GSS}	Gate-Body leakage current	V _{DS} =0V, V _{GS} = ±20V			100	nA
V _{GS(th)}	Gate Threshold Voltage	V _{DS} =V _{GS} , I _D =250μA	1	2.1	3	V
I _{D(ON)}	On state drain current	V _{GS} =10V, V _{DS} =5V	60			A
R _{DS(ON)}	Static Drain-Source On-Resistance	V _{GS} =10V, I _D =20A T _J =125°C		16 31	20	mΩ
		V _{GS} =4.5V, I _D =20A		20	25	mΩ
g _{FS}	Forward Transconductance	V _{DS} =5V, I _D =20A	4.5	5.6		S
V _{SD}	Diode Forward Voltage	I _S =1A, V _{GS} =0V		0.74	1	V
I _S	Maximum Body-Diode Continuous Current				4	A
DYNAMIC PARAMETERS						
C _{iss}	Input Capacitance	V _{GS} =0V, V _{DS} =30V, f=1MHz		1920	2300	pF
C _{oss}	Output Capacitance			155		pF
C _{rss}	Reverse Transfer Capacitance			116		pF
R _g	Gate resistance	V _{GS} =0V, V _{DS} =0V, f=1MHz		0.65	0.8	Ω
SWITCHING PARAMETERS						
Q _g (10V)	Total Gate Charge	V _{GS} =10V, V _{DS} =30V, I _D =20A		47.6	68	nC
Q _g (4.5V)	Total Gate Charge			24.2	30	nC
Q _{gs}	Gate Source Charge			6		nC
Q _{gd}	Gate Drain Charge			14.4		nC
t _{D(on)}	Turn-On Delay Time	V _{GS} =10V, V _{DS} =30V, R _L =1.5Ω, R _{GEN} =3Ω		7.4		ns
t _r	Turn-On Rise Time			5.1		ns
t _{D(off)}	Turn-Off Delay Time			28.2		ns
t _f	Turn-Off Fall Time			5.5		ns
t _{rr}	Body Diode Reverse Recovery Time	I _F =20A, di/dt=100A/μs		34	41	ns
Q _{rr}	Body Diode Reverse Recovery Charge	I _F =20A, di/dt=100A/μs		46		nC

A: The value of R_{θJA} is measured with the device mounted on 1in² FR-4 board with 2oz. Copper, in a still air environment with T_A=25°C. The Power dissipation P_{DSM} is based on R_{θJA} and the maximum allowed junction temperature of 150°C. The value in any a given application depends on the user's specific board design, and the maximum temperature fo 175°C may be used if the PCB allows it.

B: The power dissipation P_D is based on T_{J(MAX)}=175°C, using junction-to-case thermal resistance, and is more useful in setting the upper dissipation limit for cases where additional heatsinking is used.

C: Repetitive rating, pulse width limited by junction temperature T_{J(MAX)}=175°C.

D: The R_{θJA} is the sum of the thermal impedance from junction to case R_{θJC} and case to ambient.

E: The static characteristics in Figures 1 to 6 are obtained using <300μs pulses, duty cycle 0.5% max.

F: These curves are based on the junction-to-case thermal impedance which is measured with the device mounted to a large heatsink, assuming a maximum junction temperature of T_{J(MAX)}=175°C.

G: The maximum current rating is limited by bond-wires.

H: These tests are performed with the device mounted on 1 in 2 FR-4 board with 2oz. Copper, in a still air environment with T_A=25°C. The SOA curve provides a single pulse rating.

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TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

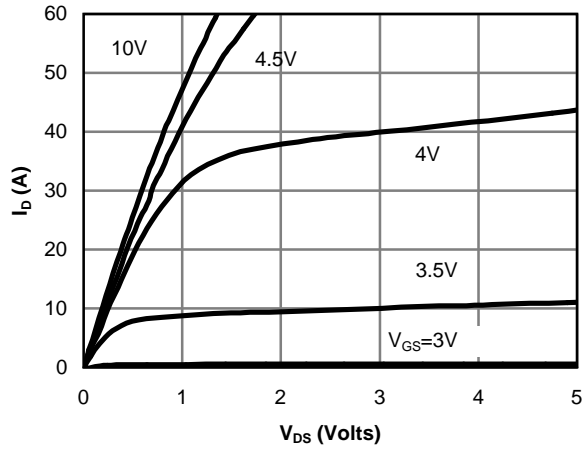


Fig 1: On-Region Characteristics

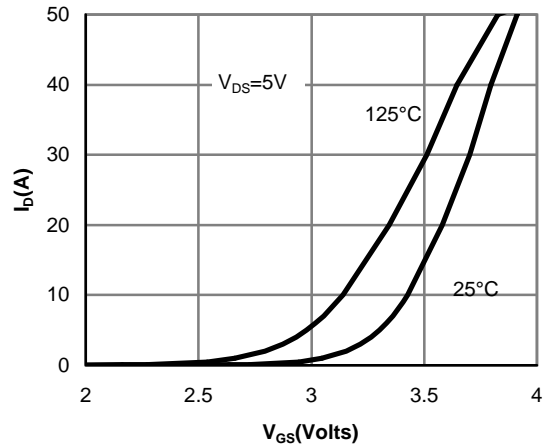


Figure 2: Transfer Characteristics

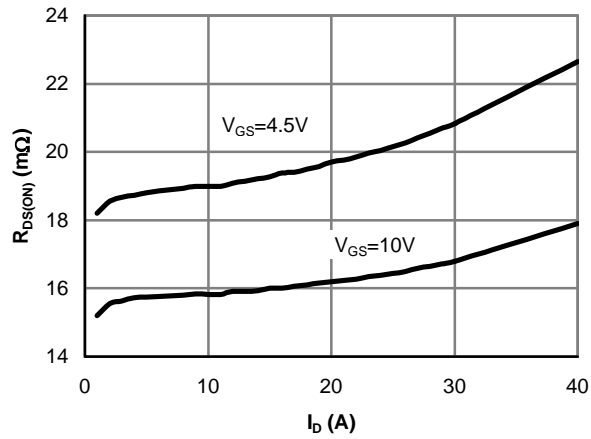


Figure 3: On-Resistance vs. Drain Current and Gate Voltage

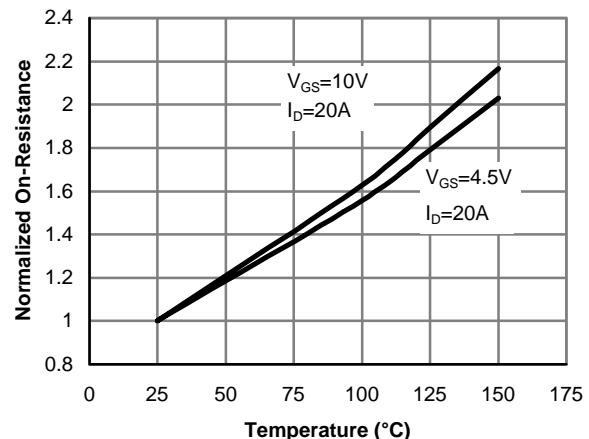


Figure 4: On-Resistance vs. Junction Temperature

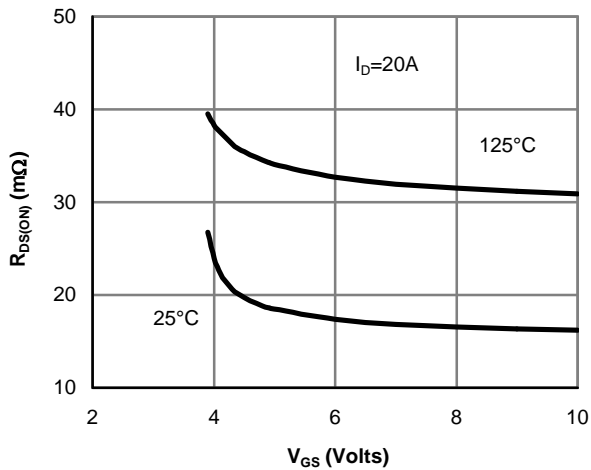


Figure 5: On-Resistance vs. Gate-Source Voltage

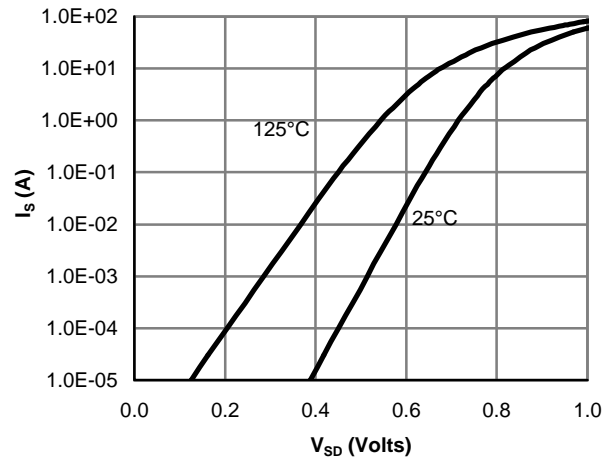


Figure 6: Body-Diode Characteristics

TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

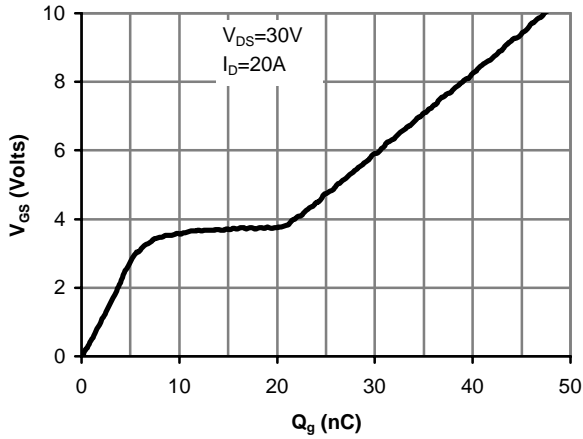


Figure 7: Gate-Charge Characteristics

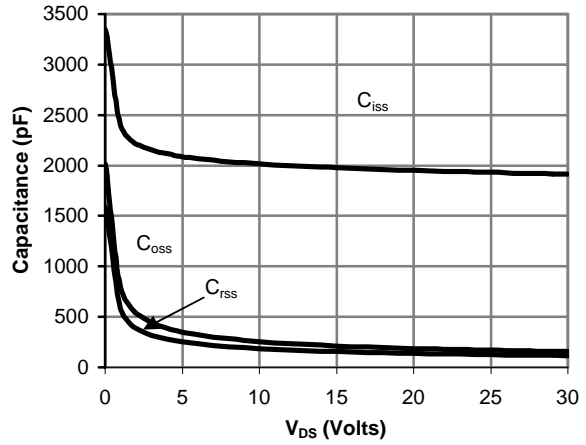


Figure 8: Capacitance Characteristics

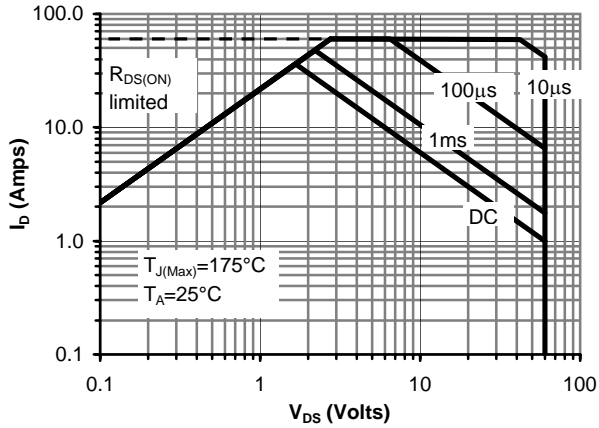


Figure 9: Maximum Forward Biased Safe Operating Area (Note F)

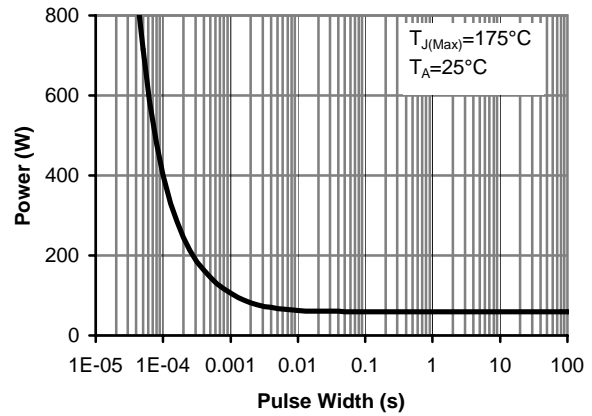


Figure 10: Single Pulse Power Rating Junction-to-Ambient (Note F)

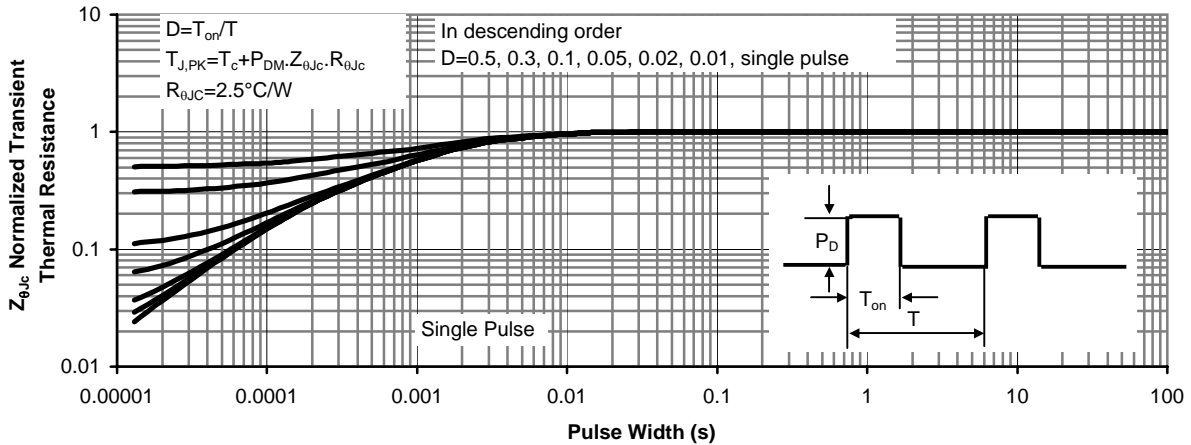


Figure 11: Normalized Maximum Transient Thermal Impedance (Note F)

TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

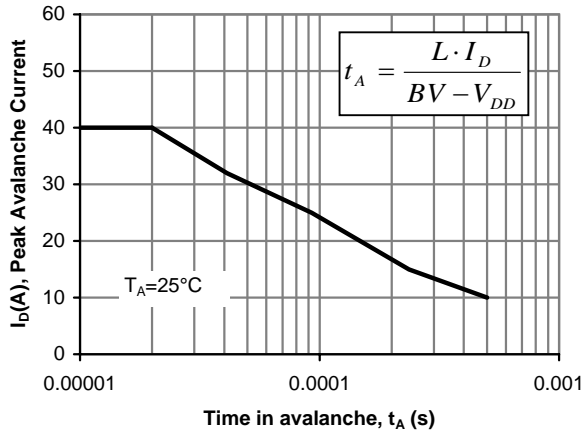


Figure 12: Single Pulse Avalanche capability

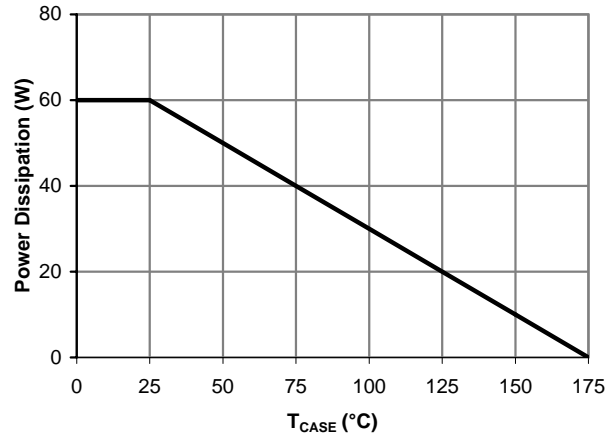


Figure 13: Power De-rating (Note B)

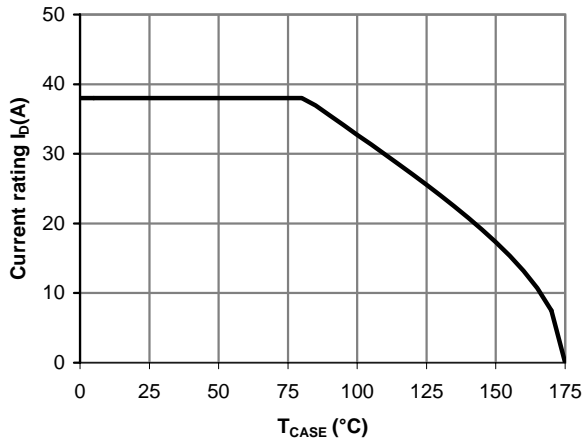


Figure 14: Current De-rating (Note B)

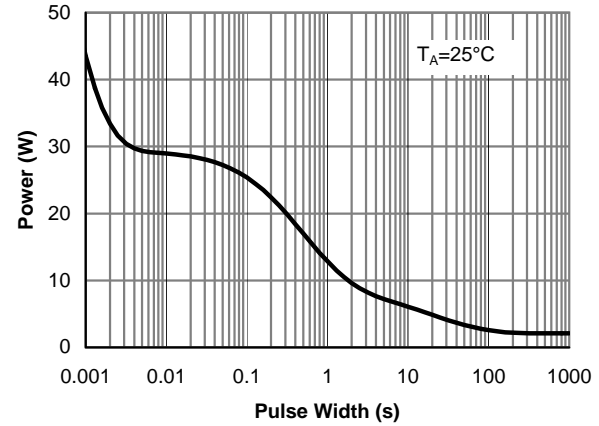


Figure 15: Single Pulse Power Rating Junction-to-Ambient (Note H)

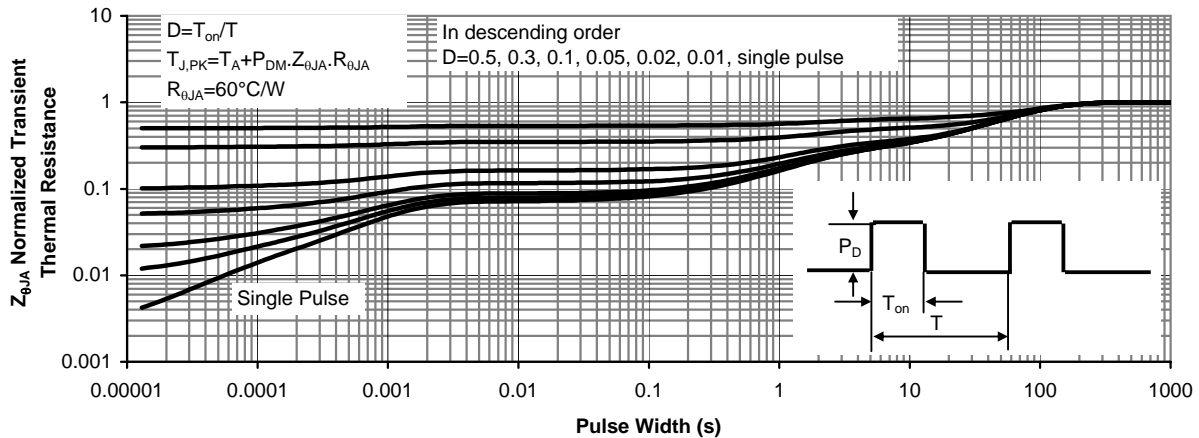
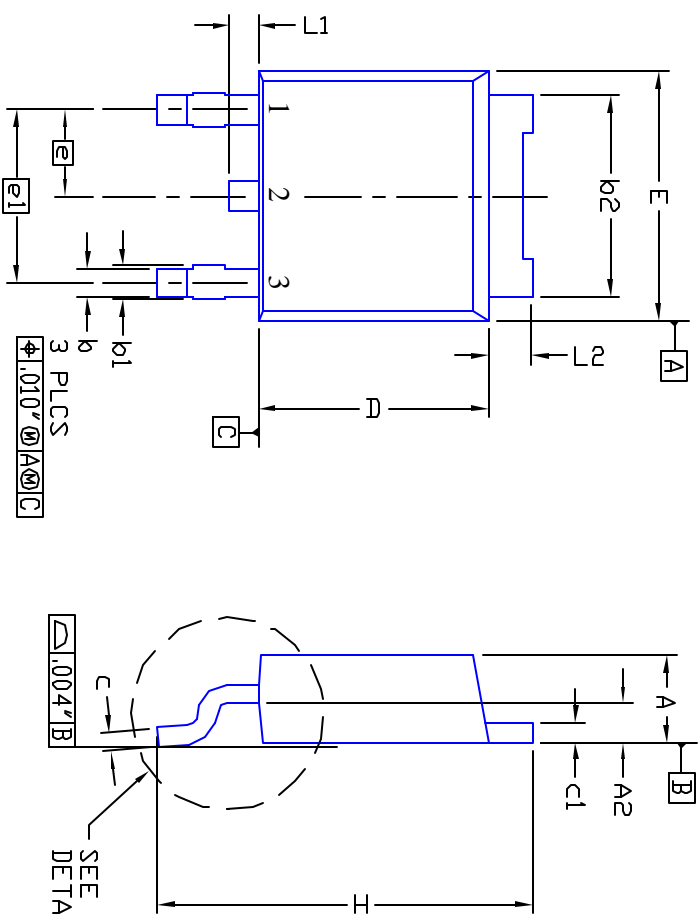


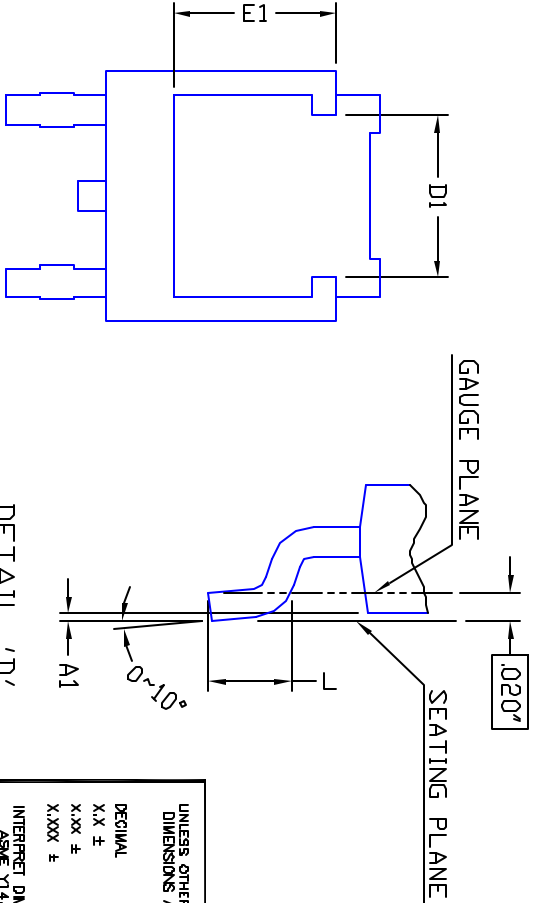
Figure 16: Normalized Maximum Transient Thermal Impedance (Note H)

REVISION HISTORY				
REV	DESCRIPTION	DATE	DRAWN	RELEASED
A	INITIAL RELEASE	7/29/02	L. LUD	L. LUD

- NOTE
1. PACKAGE BODY SIZES EXCLUDE MOLD FLASH AND GATE BURRS
 2. DIMENSION L IS MEASURED IN GAGE PLANE
 3. TOLERANCE 0.10 mm UNLESS OTHERWISE SPECIFIED
 4. CONTROLLING DIMENSION IS MILLIMETER. CONVERTED INCH DIMENSIONS ARE NOT NECESSARILY EXACT.
 5. FOLLOWED FROM JEDEC TO-252 (AA)



SYMBOL	DIMENSION IN MILLIMETERS			DIMENSIONS IN INCHES		
	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.
A	2.235	2.286	2.388	0.088	0.090	0.094
A1	0.000	0.102	0.000	0.004
A2	0.889	1.143	0.035	0.045
b	0.686	0.762	0.889	0.027	0.030	0.035
b1	0.889	1.143	0.035	0.045
b2	5.207	4.45	5.461	0.205	0.215
c	0.457	0.508	0.559	0.018	0.020	0.022
c1	0.483	0.584	0.019	0.023
D	5.969	6.096	6.223	0.235	0.240	0.245
D1	4.318	5.334	0.170	0.210
E	6.477	6.604	6.731	0.255	0.260	0.265
E1	4.318	0.170
e	2.286 BSC.			0.090 BSC.		
e1	4.572 BSC.			0.180 BSC.		
H	9.779	10.414	0.385	0.410
L	1.270	2.032	0.050	0.080
L1	0.635	1.016	0.025	0.040
L2	0.889	1.270	0.035	0.050



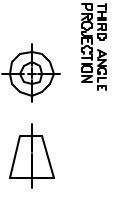
DETAIL 'D'
SCALE: 1.5X

UNLESS OTHERWISE SPECIFIED
DIMENSIONS ARE IN INCHES

DECIMAL ANGULAR
X.X ± ±
X.XX ±
X.XXX ±

INTERPRET DIM AND TOL PER
ASME Y14.5M - 1994

PRINTING IS SCALED TO FIT
DO NOT SCALE DRAWING



APPROVALS		DATE		TITLE	
DESIGN	L. LUD	7/29/02			
CHECKED	L. LUD	7/29/02			
APPROVED	Y. HD	7/29/02			

SCALE: NTS

DWG NUMBER: PO-00009

SHEET: 1 OF 1

REV: A

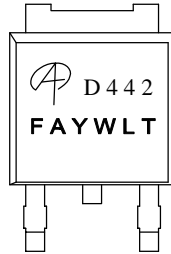
DPK (TO-252 AA)
CASE OUTLINE DRAWING



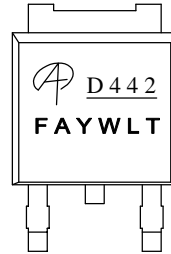
ALPHA & OMEGA
SEMICONDUCTOR, LTD.

Document No.	PD-00256
Version	rev B
Title	AOD442 Marking Description

DPAK PACKAGE MARKING DESCRIPTION



Standard product



Green product

NOTE:
LOGO - AOS LOGO
D442 - PART NUMBER CODE.
F&A - FOUNDRY AND ASSEMBLY LOCATION
Y - YEAR CODE
W - WEEK CODE.
L T - ASSEMBLY LOT CODE

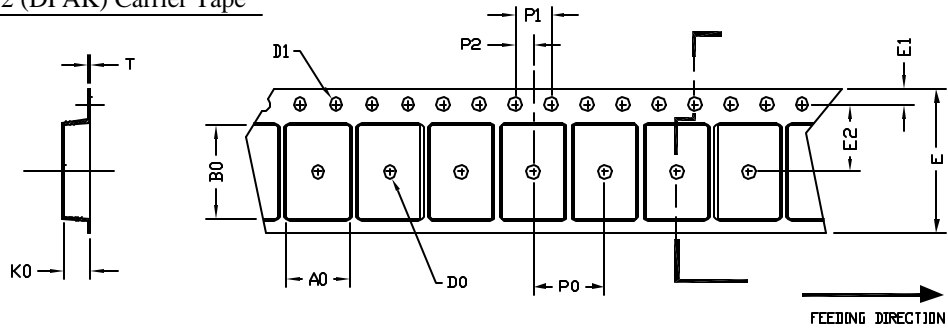
PART NO.	DESCRIPTION	CODE
AOD442	Standard product	D442
AOD442L	Green product	<u>D442</u>



ALPHA & OMEGA
SEMICONDUCTOR, LTD.

TO-252 (DPAK)
Tape and Reel Data

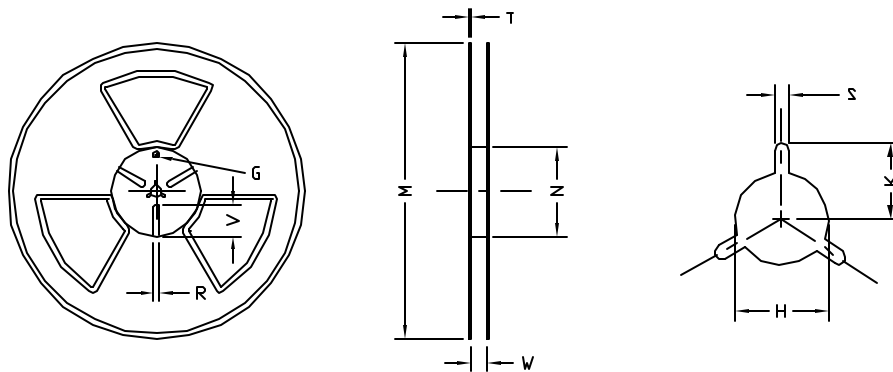
TO-252 (DPAK) Carrier Tape



UNIT: MM

PACKAGE	A0	B0	K0	D0	D1	E	E1	E2	P0	P1	P2	T
TO-252(DPAK) (16 mm)	6.90 ±0.10	10.50 ±0.10	2.70 ±0.10	1.50 ±0.10	1.50 MIN.	16.00 ±0.10	1.75 ±0.10	7.50 ±0.10	8.00 ±0.10	4.00 ±0.10	2.00 ±0.10	0.30 ±0.05

TO-252 (DPAK) Reel



UNIT: MM

TAPE SIZE	REEL SIZE	M	N	W	T	H	K	S	G	R	V
16 mm	φ330	φ330.00 ±0.10	φ99.50 ±0.10	17.50 ±0.50	2.30	φ13.50 ±0.10	10.60	2.50 ±0.10	---	---	---

TO-252 (DPAK)

Leader / Trailer
& Orientation

